



PR/095215 | R&D Manager - PCB

Job Information

Recruiter

JAC Recruitment Singapore

Job ID

1540537

Industry

Electronics, Semiconductor

Job Type

Permanent Full-time

Location

Singapore

Salary

Negotiable, based on experience

Refreshed

May 20th, 2025 12:19

General Requirements

Minimum Experience Level

Over 3 years

Career Level

Mid Career

Minimum English Level

Business Level

Minimum Japanese Level

Business Level

Minimum Education Level

Associate Degree/Diploma

Visa Status

No permission to work in Japan required

Job Description

Company and Job Overview

Our client is a leading PCB manufacturer. We are looking for an R&D Manager to develop advanced PCB technologies, materials, and processes to enhance product performance, reliability, and manufacturability.

Responsibilities

Research and develop new PCB materials, stack-ups, and manufacturing processes to improve performance, cost efficiency, and reliability

Design and optimize high-speed, high-frequency, HDI (High-Density Interconnect), and rigid-flex PCBs for various applications.

Conduct feasibility studies, simulations (signal integrity, thermal, EMI/EMC), and prototyping to validate new designs and technologies.

Collaborate with PCB fabrication, assembly, and testing teams to ensure manufacturability and quality standards.

Stay updated with industry trends, emerging technologies (e.g., embedded components, advanced substrates), and IPC standards.

Troubleshoot and resolve technical challenges related to PCB design, fabrication, and assembly.

Work with customers and suppliers to define technical requirements and develop customized solutions.

Document R&D findings, prepare technical reports, and present recommendations to stakeholders.

Support patent applications and intellectual property development for innovative PCB technologies.

Qualifications & Experience:

Education: Bachelor's/Master's degree in Electrical/Electronics Engineering, Chemistry/Chemical engineering, Materials Science, Mechanical Engineering, or related field.

Preferably 1-3 years in management of PCB design, fabrication, or R&D (experience with high-frequency/RF, High speed PCBs is a plus).

Knowledge of IPC standards, DFM (Design for Manufacturability), and signal integrity analysis and familiarity with high laminate such as low loss dielectrics is a strong plus

Familiarity with AI/ML applications in PCB design

Experience with thermal management, EMI shielding, or embedded passive/active components.

Knowledge of additive manufacturing (3D printing) for PCBs

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#LI-JACSG #countrysingapore

Company Description